





General Purpose Peak EMI Reduction IC

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Features

- Generates a 4x low EMI spread spectrum clock
- Input Frequency: 16.667MHz
- Output Frequency: 66.66MHz
- Tri-level frequency Deviation Selection:
- Down Spread, Center Spread and No Spread
- Low inherent Cycle-to-Cycle Jitter
- Supply Voltage: 3.3V±0.3V
- . LVCMOS Input and output
- 6L-TSOT-23 (6L-TSOT-26) Package

Product Description

The PCS3P8103A is a versatile spread spectrum frequency modulator designed specifically to provide a 4x output of 66.66MHz from an input clock of 16.667MHz.

The PCS3P8103A reduces electromagnetic interference (EMI) at the clock source, allowing system wide reduction of EMI of down stream clock and data dependent signals. It allows significant system cost savings by reducing the

number of circuit board layers, ferrite beads, shielding, and other passive components that are traditionally required to pass EMI regulations.

The custom device can generate an EMI reduced clock from crystal, or system clock.

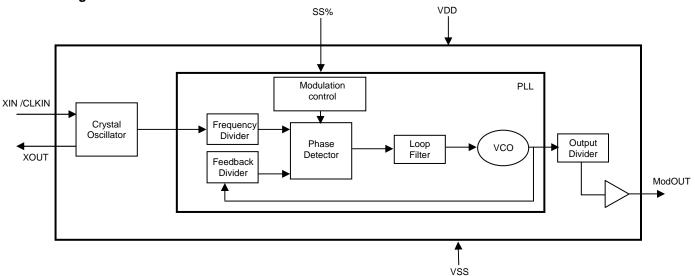
The PCS3P8103A has a 3 level logic control SS% for selecting Center Spread, Down Spread and No-Spread options. Refer to *Output Frequency Deviation table*.

The PCS3P8103A operates from a 3.3V±0.3V supply Voltage and is available in a 6L-TSOT-23 package.

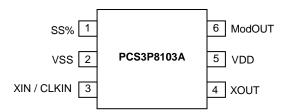
Application

The PCS3P8103A is targeted towards EMI management in applications such as LCD Panels, MFPs, Digital copiers, Networking, PC peripheral devices, consumer electronics, and embedded controller systems.

Block Diagram



Pin Configuration



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Pin Description

	SCHPHOH				
Pin#	Pin Name	Pin Name Type Description			
1	SS%	I	Tri-level logic input (1-M-0) used to select Down spread, No spread, and Center spread options. (Refer to <i>Output Frequency Deviation Selection Table</i>). Default=M.		
2	VSS	Р	Ground to entire chip.		
3	XIN / CLKIN	I	Crystal connection or External Clock input.		
4	XOUT	XOUT O Crystal connection. If using an external reference, this pin must be left unconnected.			
5	VDD	Р	Power supply for the entire chip.		
6	ModOUT	0	Spread Spectrum Clock Output.		

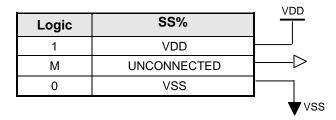
Output Frequency Deviation Selection Table

CLKIN	SS%=0	SS%=1	SS%=M
(MHz)	Center	Down	No Spread
16.667	±1.2%	-0.7%	0

Tri-Level Logic

SS% digital input is designed to sense 3 different logic levels designated as High "1", Low "0" and Middle "M". No

external application resistors are needed to implement the 3-Level logic control as shown:



Operating Conditions

Symbol	Parameter	Min	Max	Unit
VDD	Voltage on any input pin with respect to VSS	3.0	3.6	V
T _A	Operating temperature	0	+70	C
CL	Load Capacitance		15 ^{VVVV}	v.DataEheet
C _{IN}	Input Capacitance		7	pF

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Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit	
VDD, V _{IN}	Voltage on any pin with respect to Ground	-0.5 to +4.6	V	
T _{STG}	Storage temperature	-65 to +125	C	
Ts	Max. Soldering Temperature (10 sec)	260	C	
TJ	Junction Temperature	150	C	
T_DV	Static Discharge Voltage (As per JEDEC STD 22- A114-B)	2	KV	

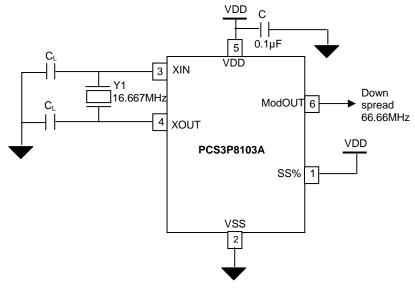
DC Electrical Characteristics

Symbol	Parameter				Min	Тур	Max	Unit
VDD	Supply Voltage				3	3.3	3.6	
	Input low voltage		Comr	mercial temperature	0		0.15VDD	V
V_{IL}			Indus	trial temperature	0		0.13 VDD	
V_{IM}	Input Middle Voltage				0.4VDD		0.60VDD	
V _{IH}	Input high voltage			0.85VDD		VDD	V	
V _{OL}	Output low voltage (ModOUT Output)			I _{OL} =4mA			0.4	V
V_{OH}	Output high voltage (ModOUT Output)			I _{OH} = -4mA	2.4			V
C _{IN}	Input Capacitance (X	(IN And	XOUT)		6		9	pF
I	Dynamic supply current	Comm	mercial temperature				10	mA
I _{DD}	(Unloaded Output)	Industr	ial tem	perature			12	mA
I _{CC}	Static supply current (XIN / CLKIN pulled to VSS)				0.5	mA		
Note. The vol	tage on any input or I/O pin	cannot exc	eed the p	power pin during power up.				

AC Electrical Characteristics

Symbol	Parameter	Min	Тур	Max	Unit	
f _{IN}	Input Clock frequency		16.667		MHz	
f _{OUT}	ModOUT Clock			66.66	www.Da	MHz taSheet4
t _{LH} ^{1, 2}	ModOUT Rise time (Measured from 20%	% to 80%)			3	nS
t _{HL} ^{1, 2}	ModOUT Fall time (Measured from 80%	to 20%)			2.5	nS
TDCIN	Input Clock Duty Cycle(XIN/CLKIN)		40		60	%
TDCOUT ^{1,}	Output Clock Duty Cycle (ModOUT)		40		60	%
T _{JC} ²	Cy - Cy Jitter, For ModOUT with Spread ON			±200	±350	20
T_{JP}^2	Period Jitter, For ModOUT with Spread OFF			±150		pS
t_{ON}^2	PLL Lock Time (Stable power supply, valid input clock	Commercial temp.			2	mS
	to valid Clock on ModOUT)	Industrial temp.			3	

Application Schematic

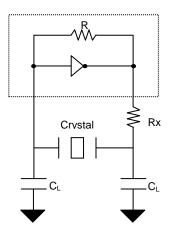


Typical Crystal Specifications

Fundamental AT cut parallel resonant	crystal	
Nominal frequency	16.667MHz	
Frequency tolerance	± 50ppm or better at 25℃	
Operating temperature range	-25℃ to +85℃	www.DataSheel4U.c
Storage temperature	-40℃ to +85℃	
Load capacitance	18pF	
Shunt capacitance	7pF maximum	
ESR	25Ω	

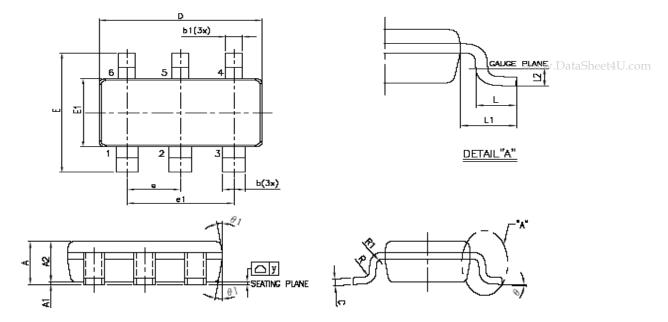
Note: C_L is Load Capacitance and Rx is used to prevent oscillations at overtone frequency of the Fundamental frequency.

Typical Crystal Interface Circuit



$$\begin{split} C_L &= 2^*(C_P - C_S),\\ \text{Where } C_P &= \text{Load capacitance of crystal.}\\ C_S &= \text{Stray capacitance due to } C_{\text{IN,}} \text{ PCB, Trace, etc.} \end{split}$$

6L-TSOT-23 Package Information



	Dimensions					
Symbol	Inch	nes	Millimeters			
	Min	Max	Min	Max		
Α	0.0295	0.035	0.75	0.90		
A1	0.00	0.0039	0.00	0.10		
A2	0.0275	0.0314	0.70	0.80		
b	0.0157	0.0197	0.40	0.50		
b1	0.0118	0.0157	0.30	0.40		
С	0.0031	0.0078	0.08	0.20		
D	0.11	41	2.90 REF			
Е	0.1023	0.1181	2.60	3.00		
E1	0.0590	0.0069	1.50	1.70		
е	0.03	374	0.9	95 BSC		
e1	0.07	' 48	1.9	00 BSC		
L	0.0118	0.0236	0.30	0.60		
L1	0.0236	REF	0.6	60 REF		
L2	0.0098 BSC		0.2	25 BSC		
R	0.0039		0.10			
R1	0.0039	0.0098	0.10	0.25		
θ	0°	8°	0°	8°		
У		0.0039		0.10		

Ordering Code

Part Number	Marking	Package Type	Temperature
PCS3P8103AG-06JR	AZ1	6L-TSOT-23 (6L-TSOT-26), TAPE & REEL, Green	0℃ to +70℃

A "microdot" placed at the end of last row of marking or just below the last row toward the center of package indicates Pb-free. DataSheet4U.com

Note: This product utilizes US Patent #6,646,463 Impedance Emulator Patent issued to PulseCore Semiconductor, dated 11-11-2003.

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